

#### **Features**

- Micropower operation
- Operation with North or South Pole
- 2.4 to 5.5V battery operation
- Chopper Stabilized
  - Superior temperature stability
  - Extremely Low Switch-Point Drift
  - Insensitive to Physical Stress
- Good RF noise immunity
- -40°C to 85°C operating temperature
- Low profile 3 pin SC59 (commonly known as SOT23 in Asia) and DFN2020-6 package
- ESD (HBM) > 4KV for DFN2020-6
- SC59 (commonly known as SOT23 in Asia) and DFN2020-6: Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

### **General Description**

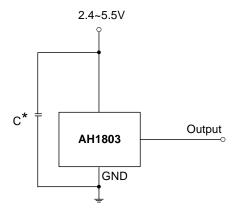
AH1803 is with two Hall effect plates and a CMOS output driver, mainly designed for battery–operation, hand-held equipment (such as Cellular and Cordless Phone, PDA). The total operation power is down to 24uW in the 3V supply.

Either North or South Pole of sufficient strength will turn the output on. The output will be turned off under no magnetic field. While the magnetic flux density (B) is larger than operate point (Bop), the output will be turned on (low), the output is held until B is lower than release point (Brp), then turned off (High).

### **Applications**

- Cellular phone
- PDA
- · Cordless phone

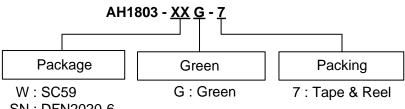
### **Typical Circuit**



\* C is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF~100nF.



## **Ordering Information**



SN: DFN2020-6

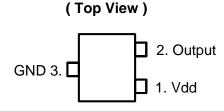
	Product	Product Package Packaging		7" Tape and Reel			
		Code	(Note 2)	Quantity	Part Number Suffix		
<u>Pb</u> ,	AH1803-WG-7	W	SC59	3000/Tape & Reel	-7		
<b>PD</b> ,	AH1803-SNG-7	SN	DFN2020-6	3000/Tape & Reel	-7		

Notes:

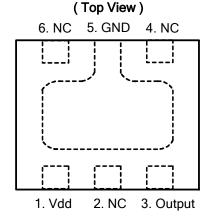
- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at
- Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

### **Pin Assignments**

(1) SC59 (commonly known as SOT23 in Asia)



(2) DFN2020-6



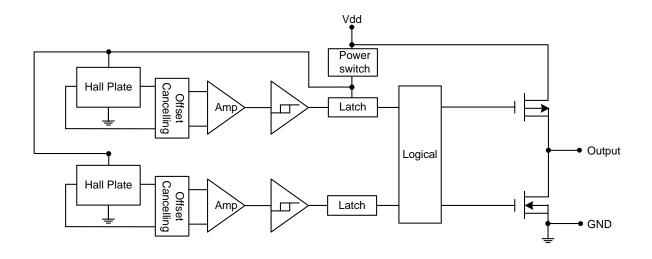
Notes: 3. NC is "No Connection", which is recommended to be tied to ground.

## **Pin Descriptions**

Pin Name	P/I/O	Description		
Vdd	P/I	Power Supply Input		
GND	P/I	Ground		
Output	0	Output Pin		
NC		No Connected		



### **Block Diagram**



## Absolute Maximum Ratings (at T<sub>A</sub>= 25°C)

Symbol	Characteristi	Values	Unit	
Vdd	Supply voltage	7	V	
В	Magnetic flux density	Unlimited		
Ts	Storage Temperature Range	-65 to +150	°C	
P <sub>D</sub>	Package Power Dissipation	SC59	230	mW
ГD	Package Fower Dissipation	230	mW	
$T_J$	Maximum Junction Temperature	150	°C	

## Recommended Operating Conditions $(T_A = 25^{\circ}C)$

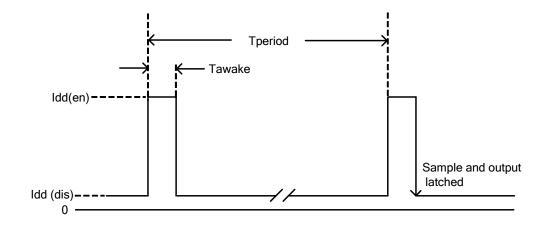
Symbol	Parameter	Conditions	Rating	Unit
Vdd	Supply Voltage	Operating	2.4~5.5	V
T <sub>A</sub>	Operating Temperature Range	Operating	-40 to +85	°C



### Electrical Characteristics (TA= +25°C, Vdd= 3V; unless otherwise specified)

Symbol	Characteristic	Conditions	Min	Тур.	Max	Unit
V <sub>OH</sub>	Output On Voltage (High side)	I <sub>OUT</sub> = -1mA	Vdd-0.2	-	ı	V
$V_{OL}$	Output On Voltage (Low side)	$I_{OUT} = 1mA$	-	-	0.1	V
Idd(en)		Chip enable, $T_A = 25$ °C, Vdd = 3V	-	3	6	mA
laa(en)		Chip enable, $T_A = -40 \sim 85$ °C, Vdd = 2.4 $\sim 5.5$ V	-	3	9	mA
Idd(dis)	Supply Current	Chip disable, $T_A = 25^{\circ}C$ , Vdd = 3V	-	5	10	μΑ
iuu(uis)	Supply Current	Chip disable, $T_A = -40 \sim 85$ °C, Vdd = 2.4~5.5V	-	5	18	μΑ
ldd(avg)		Average supply current, $T_A = 25^{\circ}C$ , Vdd = 3V	-	8	16	μΑ
luu(avg)		Average supply current, $T_A = -40 \sim 85^{\circ}C$ , $Vdd = 2.4 \sim 5.5V$	-	8	27	μΑ
Tawake	Awake Time	(Note 5)	-	75	150	μs
Tperiod	Period	(Note 5)	-	75	150	ms
D.C.	Duty Cycle		-	0.1	ı	%

Notes: 5. When power is initially on, the operating Vdd (2.4V to 5.5V) must be applied to be guaranteed for the output sampling. The output state is valid after the second operating phase (typical 150ms).





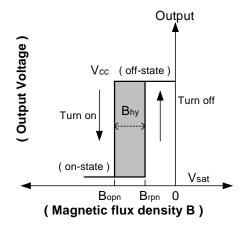
## Magnetic Characteristics (TA = 25°C, Vdd = 3V, Note 6, 7)

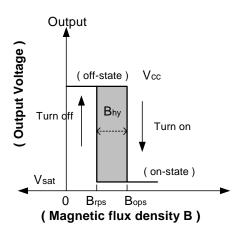
(1mT = 10G)

Symbol	Parameter	Min	Тур.	Max	Unit
Bops(south pole to brand side)	Operation Point	2	3	4	
Bopn(north pole to brand side)	Operation Foint	-4	-3	-2	
Brps(south pole to brand side)	Release Point	1	2	-	mT
Brpn(north pole to brand side)		-	-2	-1	
Bhy( Bopx – Brpx )	Hysteresis	0.5	1	-	

Notes: 6. Typical data is at T<sub>A</sub>=25 °C, Vdd=3V, and for design information only.

7. Magnetic characteristics are for design information, which will vary with supply voltage, operating temperature and after soldering.

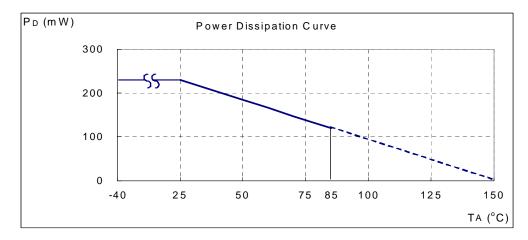




### **Performance Characteristics**

(1) SC59 (commonly known as SOT23 in Asia) and DFN2020-6

TA (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
PD (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0

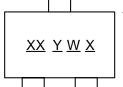




## **Marking Information**

#### (1) SC59 (commonly known as SOT23 in Asia)

#### (Top View)



XX: Identification code

Y: Year 0~9

 $\underline{W}$ : Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents

52 and 53 week

X : A~Z : Green

Part Number	Package	Identification Code
AH1803	SC59	KD

#### (2) DFN2020-6

(Top View)

--▶Pin 1 indicator

<u>X X</u> • <u>YWX</u>

XX: Identification Code

Y: Year: 0~9

W: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents

52 and 53 week

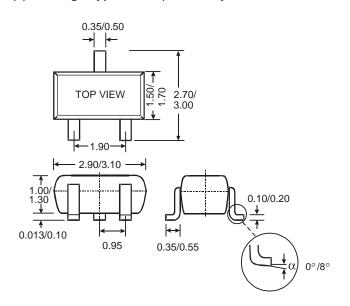
 $\underline{X}$ : A~Z: Green

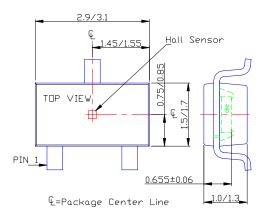
Part Number	Package	Identification Code
AH1803	DFN2020-6	KD



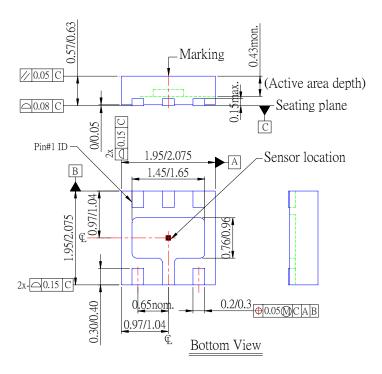
### Package Information (All Dimensions in mm)

#### (1) Package Type: SC59 (commonly known as SOT23 in Asia)





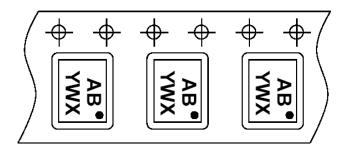
#### (2) Package Type: DFN2020-6

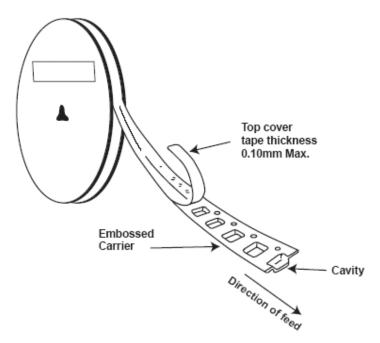




## **Taping Orientation**

#### For DFN2020-6





Notes: 8. The taping orientation of the other package type can be found on our website at <a href="http://www.diodes.com/datasheets/ap02007.pdf">http://www.diodes.com/datasheets/ap02007.pdf</a>.



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